

Title (en)

A METHOD OF FORMING AN EMBOSSED CHARACTER ON AN IC CARD

Publication

EP 0385583 A3 19901017 (EN)

Application

EP 90301020 A 19900131

Priority

JP 2349489 A 19890131

Abstract (en)

[origin: EP0385583A2] A method of forming an embossed character on an IC card, comprising the steps of: applying a viscous resin, which adheres to the surface of the IC card and hardens when exposed to ultraviolet light, onto the surface of the IC card while forming a desired character with the resin; and projecting ultraviolet light onto the surface of the IC card so as to harden the resin applied in the form of the desired character.

IPC 1-7

B42D 15/02

IPC 8 full level

B42D 25/305 (2014.01); **B42D 25/405** (2014.01); **G06K 1/12** (2006.01)

CPC (source: EP US)

B42D 25/00 (2014.10 - EP); **B42D 25/415** (2014.10 - EP US); **B42D 25/324** (2014.10 - EP); **B42D 25/485** (2014.10 - EP); **B42D 2033/46** (2022.01 - EP)

Citation (search report)

- [X] FR 2600590 A1 19871231 - TOSHIBA KK [JP]
- [A] EP 0189125 A1 19860730 - INTERLOCK SICHERHEITSSYST [CH]
- [A] EP 0249266 A1 19871216 - PAPIER PLASTIC COATING GRONING [NL]
- [A] GB 2191029 A 19871202 - ALMEX SYSTEMS LTD
- [A] PATENT ABSTRACTS OF JAPAN vol. 9, no. 230 (E-343)(1953) 17 September 1985, & JP-A-60 84771 (SEIKO DENSHI) 14 May 1985,

Cited by

EP1674287A1; DE102005062047A1; DE102005062047B4

Designated contracting state (EPC)

DE FR GB

DOCDB simple family (publication)

EP 0385583 A2 19900905; EP 0385583 A3 19901017; JP H02202495 A 19900810

DOCDB simple family (application)

EP 90301020 A 19900131; JP 2349489 A 19890131